

## DESCRIPTION

SSRs will only achieve their promise of reliability and long life if they are kept cool. Normally it is suggested to keep the temperature of the SSR metal base at less than 85°C (185°F). Heatsinks can be an effective solution to ensure the proper operation and long term reliability of SSRs, because they provide a means to dissipate the power that is normally developed internally in the SSR into the surrounding ambient air and maintain a safe operating temperature. And it is very important to know how to select and use a heatsink for the reason that the heatsink directly affects the Max. load current and the Max. ambient temperature that the SSR can endure.

Heatsinks are made of high thermal conductive material such as aluminum. Usually the metal base of the SSR will be coated with some thermal grease or a thermal pad to enhance heat dissipation, and then the SSR will be firmly pressed against the heatsink for full adherence. For high-power SSRs the wind cooling should be required. Insufficient thermal dissipation may cause permanent damage to the SSR due to overheating.

## We can use a simple thermal model to calculate the heat dissipation as follows:

T1-TA=P X R1A

In the above formula T, stands for the junction temperature of the power parts of semiconductor(°C), TA stands for the ambient temperature (°C), P stands for general power consumption (W) and R<sub>1A</sub> stands for thermal resistance (°C/W) from junction to ambient. The thermal resistance of simplified SSR relays is made up of two parts as follow: R<sub>JA</sub>=R<sub>JC</sub>+R<sub>CA</sub>. In the formula, R<sub>1c</sub> stands for thermal resistance from junction to case and R<sub>ca</sub> stands for the thermal resistance from case to ambient

For example, when we calculate the heat dissipation of KS15/ D-24Z25, R<sub>3C</sub> of this relay is about 1.2°C/W, R<sub>CA</sub> is about 8.5°C/ W. The max. allowable junction temperature is 12°c and the power consumption is P=U x I. When the current is 10A or below 10A, the TRIAC voltage drop is about 1.1V. The formula of product without heat sink is show as follow, 125-  $T_A$ =1.1 X I X (1.2+8.5).

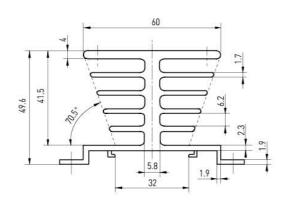
According to the above formula, the max. current is 9.3A at 25°C ambient temperature and 6A at 60°C ambient temperature when the product dose not add a heat sink.

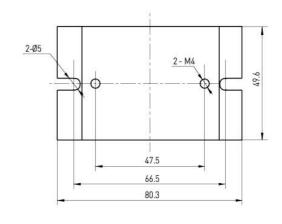
If we add HF92B-120 heat sink to this relay and the reference thermal resistance is about 1.1°C/W. Neglecting the thermal resistance from SSR metal base to heat sink, and the voltage drop is about 1.25V on full load current. The formula will be 125- TA=1.5 X I X (1.2+1.1). Max. ambient temperature will be 40°C when the operating current is 25A and the max. current will be 18A when the ambient temperature is 60°C. Due to the different heat sink types, the corresponding thermal resistance changes. So there are different current values under corresponding ambient temperature.

Part Number	Dimensions (mm)	Thermal Resistance	Matching SSR
HF92B-80	50x50x80	2.4°C /W	KS15: 10A, 15A KS33: 30D50, 50D40, 200D10 KS53: 10A
HF92B-120	64x110x18	1.1°C /W	KS15: 20A, 25A KS33: 400D10, 150D50, 100D20, 500D7, 500D12 KS34: 25A KS53: 15A, 20A
HF92B-150A	55x142x50	0.6°C /W	KS15: 40A KS24: 10A, 15A, 20A, 25A KS28: 25A KS33: 50D80, 100D40, 200D40, 30D100 KS34: 40A, 50A KMRS: 10A, 15A, 25A KMRT-H: 25A KMRT: 10A, 15A, 20A, 25A KIS70: 40A, 50A
HF92B-150C (Requiring an additional cooling fan)	80x100x110		KS24: 40A and above types KS28: 40Aand above types KS33: 100D80 KS34: 60Aand above types KS64: 10A, 15A, 20A KMRS: 40A KMRT-H: 50A KMRT: 40Aand above types KIS70: 60Aand above types

## **OUTLINE DIMENSIONS** Unit: mm

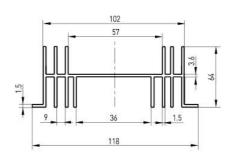
## HF92B-80

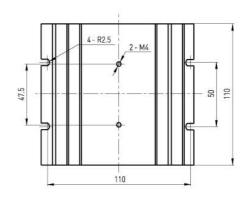




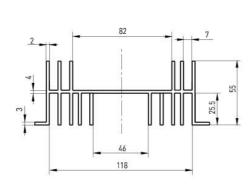
OUTLINE DIMENSIONS
Unit: mm

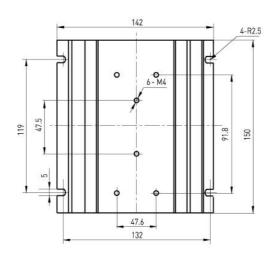
HF92B-120



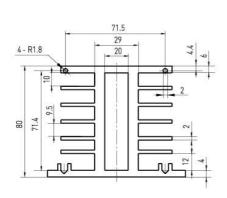


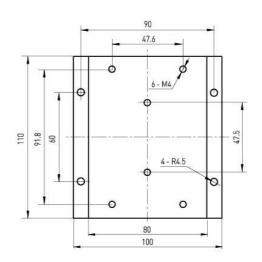
HF92B-150A





HF92B-150C





Remark: The above dimensions are typical values.